

## Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use <http://www.nexperia.com>

Instead of [sales.addresses@www.nxp.com](mailto:sales.addresses@www.nxp.com) or [sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com), use [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com) (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © **Nexperia B.V. (year). All rights reserved.**

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

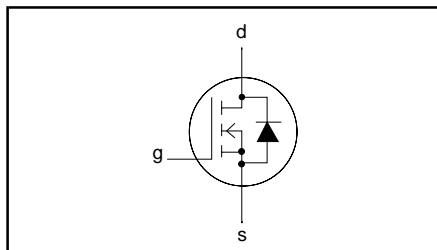
# N-channel TrenchMOS™ transistor

# PHT6NQ10T

## FEATURES

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

## SYMBOL



## QUICK REFERENCE DATA

$V_{DSS} = 100 \text{ V}$
$I_D = 6.5 \text{ A}$
$R_{DS(ON)} \leq 90 \text{ m}\Omega$

## GENERAL DESCRIPTION

N-channel enhancement mode field-effect transistor in a plastic envelope using 'trench' technology.

### Applications:-

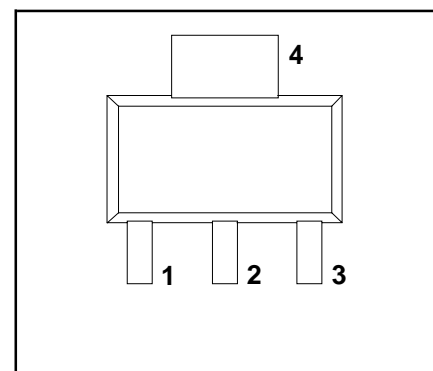
- Motor and relay drivers
- d.c. to d.c. converters

The PHT6NQ10T is supplied in the SOT223 surface mounting package.

## PINNING

PIN	DESCRIPTION
1	gate
2	drain
3	source
4	drain (tab)

## SOT223



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DSS}$	Drain-source voltage	$T_j = 25 \text{ }^\circ\text{C}$ to $150 \text{ }^\circ\text{C}$	-	100	V
$V_{DGR}$	Drain-gate voltage	$T_j = 25 \text{ }^\circ\text{C}$ to $150 \text{ }^\circ\text{C}$ ; $R_{GS} = 20 \text{ k}\Omega$	-	100	V
$V_{GS}$	Gate-source voltage		-	$\pm 20$	V
$I_D$	Continuous drain current (dc)	$T_{sp} = 25 \text{ }^\circ\text{C}$ $T_{amb} = 25 \text{ }^\circ\text{C}$	-	6.5	A
$I_D$	Continuous drain current (dc)	$T_{sp} = 100 \text{ }^\circ\text{C}$ $T_{amb} = 100 \text{ }^\circ\text{C}$	-	3	A
$I_{DM}$	Pulsed drain current		-	4.1	A
$P_D$	Total power dissipation	$T_{sp} = 25 \text{ }^\circ\text{C}$ $T_{amb} = 100 \text{ }^\circ\text{C}$	-	1.9	A
$T_j, T_{stg}$	Operating junction and storage temperature	$T_{sp} = 25 \text{ }^\circ\text{C}$ $T_{amb} = 25 \text{ }^\circ\text{C}$	-	26	A
			-	8.3	W
			-	1.8	W
			-65	150	$^\circ\text{C}$

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th j-sp}$	Thermal resistance junction to solder point	surface mounted, FR4 board	12	15	K/W
$R_{th j-amb}$	Thermal resistance junction to ambient	surface mounted, FR4 board	70	-	K/W

## N-channel TrenchMOS™ transistor

PHT6NQ10T

**ELECTRICAL CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified

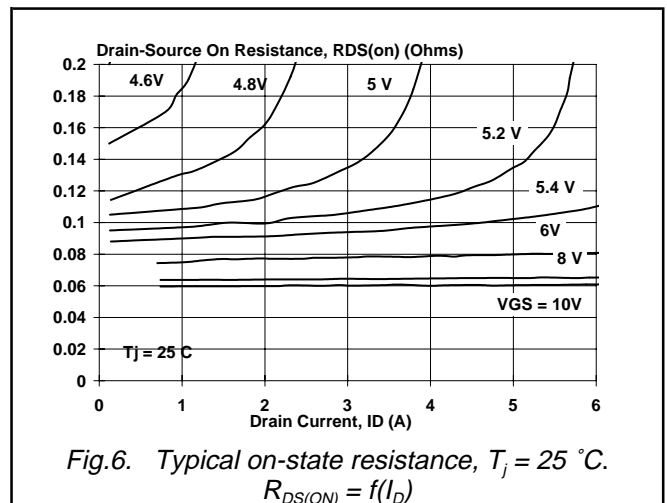
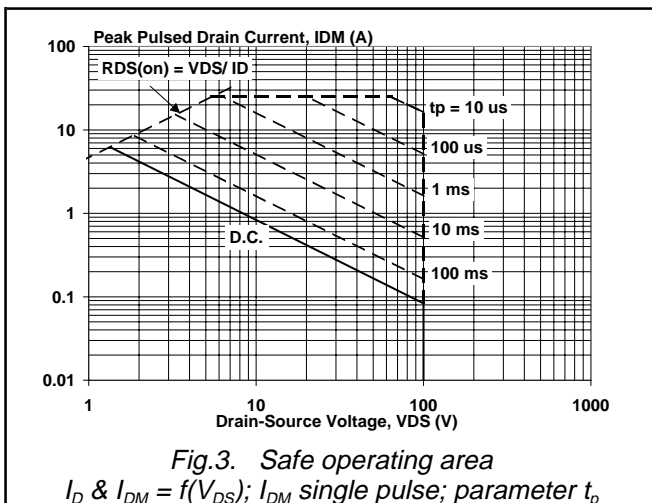
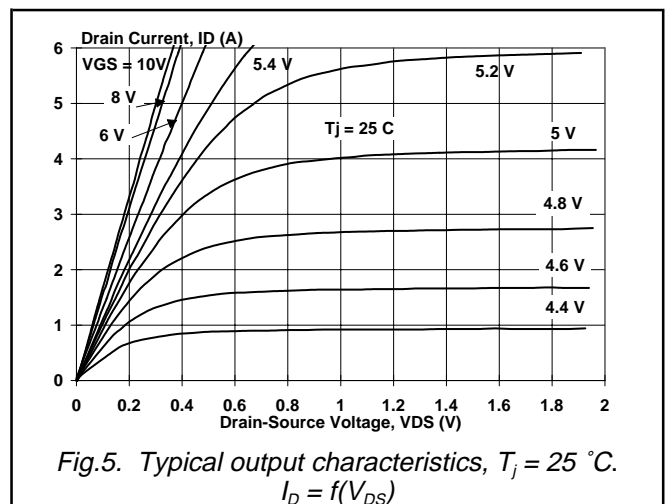
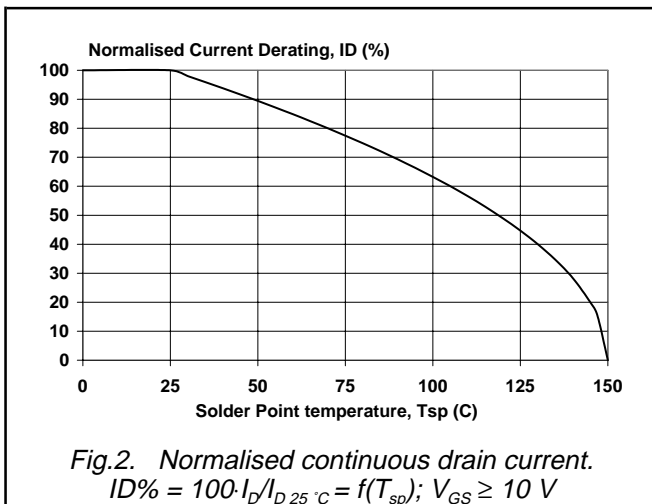
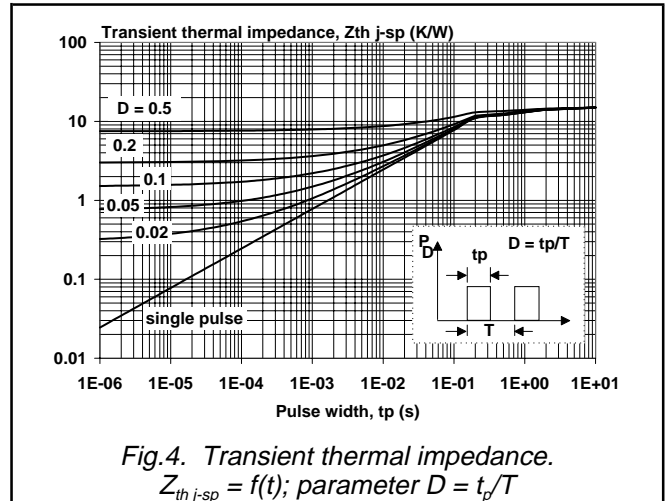
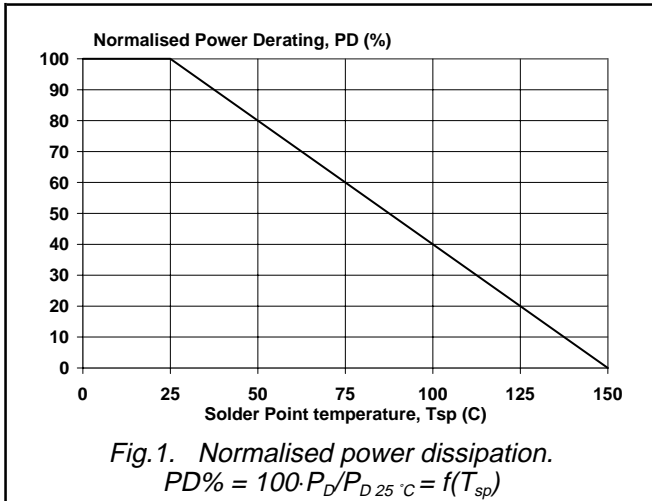
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA};$ $T_j = -55^\circ\text{C}$	100 89	- -	- -	V V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1\text{ mA}$ $T_j = 150^\circ\text{C}$ $T_j = -55^\circ\text{C}$	2 1.2 -	3 -	4 -	V V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 3\text{ A}$ $T_j = 150^\circ\text{C}$	- -	57 -	90 216	m $\Omega$ m $\Omega$
$I_{GSS}$	Gate source leakage current	$V_{GS} = \pm 10\text{ V}; V_{DS} = 0\text{ V}$	-	10	100	nA
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 100\text{ V}; V_{GS} = 0\text{ V};$ $T_j = 150^\circ\text{C}$	-	0.05	10 500	$\mu\text{A}$ $\mu\text{A}$
$Q_{g(tot)}$	Total gate charge	$I_D = 6\text{ A}; V_{DD} = 80\text{ V}; V_{GS} = 10\text{ V}$	-	21	-	nC
$Q_{gs}$	Gate-source charge		-	2.5	-	nC
$Q_{gd}$	Gate-drain (Miller) charge		-	8.2	-	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = 50\text{ V}; R_D = 8.2\ \Omega;$	-	6	-	ns
$t_r$	Turn-on rise time	$V_{GS} = 10\text{ V}; R_G = 5.6\ \Omega$	-	15	-	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	20	-	ns
$t_f$	Turn-off fall time		-	10	-	ns
$L_d$	Internal drain inductance	Measured tab to centre of die	-	2.5	-	nH
$L_s$	Internal source inductance	Measured from source lead to source bond pad	-	5	-	nH
$C_{iss}$	Input capacitance	$V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$	-	633	-	pF
$C_{oss}$	Output capacitance		-	103	-	pF
$C_{rss}$	Feedback capacitance		-	61	-	pF

**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_S$	Continuous source current (body diode)	$T_{sp} = 25^\circ\text{C}$	-	-	5.5	A
$I_{SM}$	Pulsed source current (body diode)		-	-	26	A
$V_{SD}$	Diode forward voltage	$I_F = 6\text{ A}; V_{GS} = 0\text{ V}$	-	0.8	1.2	V
$t_{rr}$	Reverse recovery time	$I_F = 6\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$	-	55	-	ns
$Q_{rr}$	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = 25\text{ V}$	-	135	-	nC

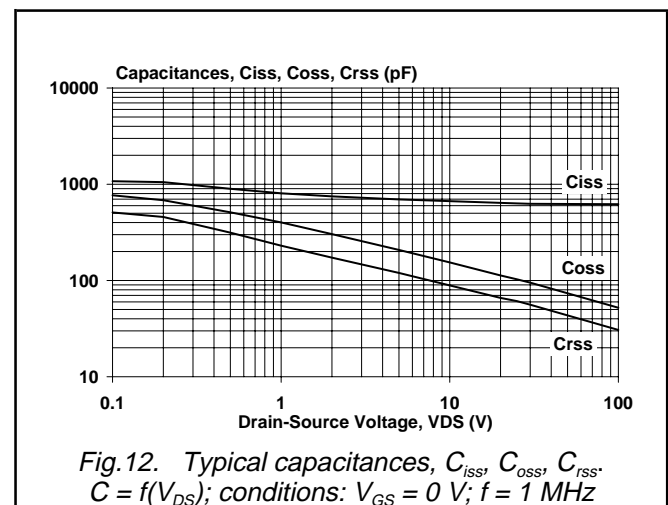
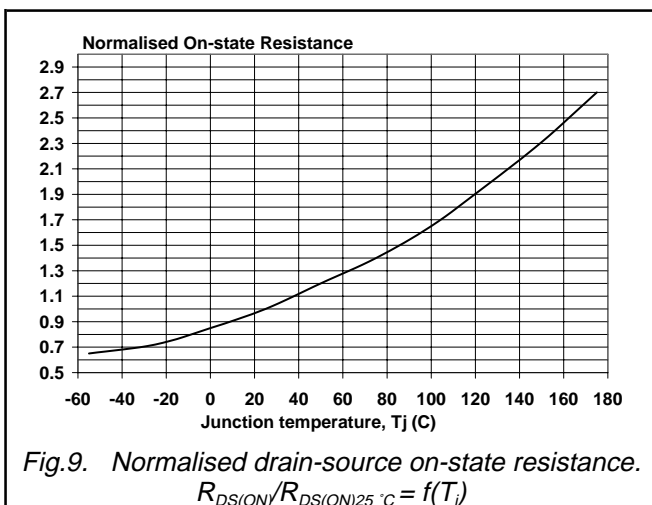
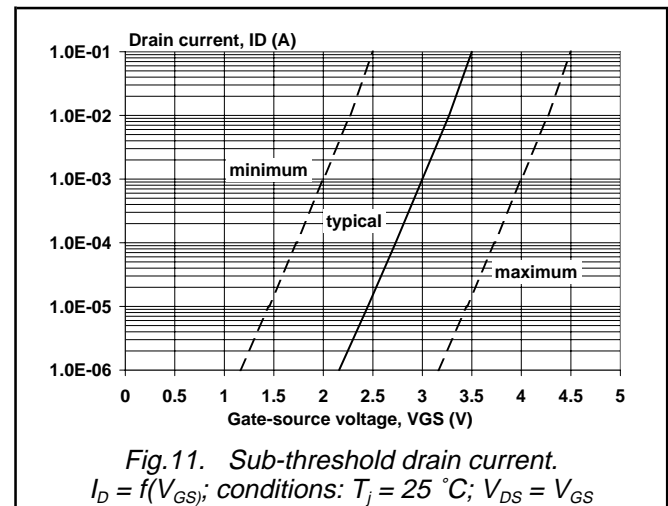
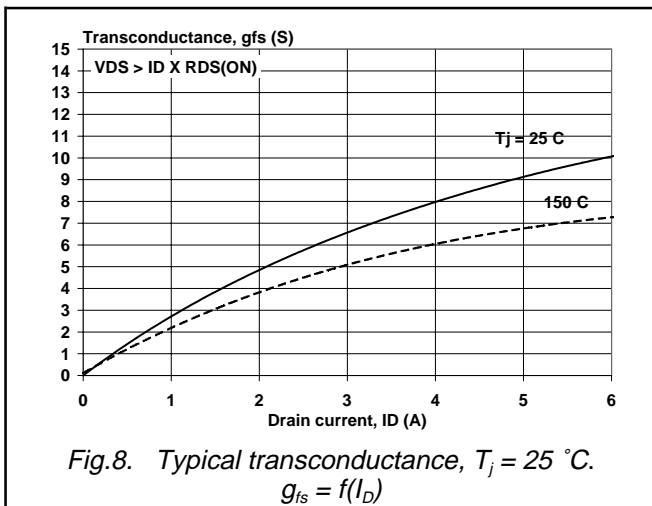
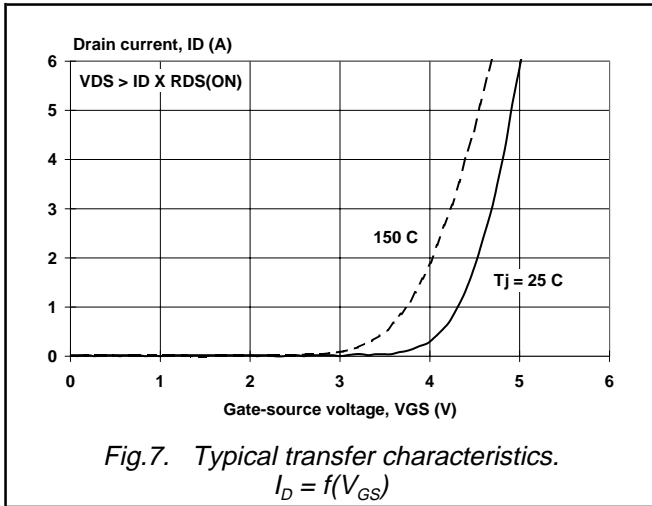
N-channel TrenchMOS™ transistor

PHT6NQ10T



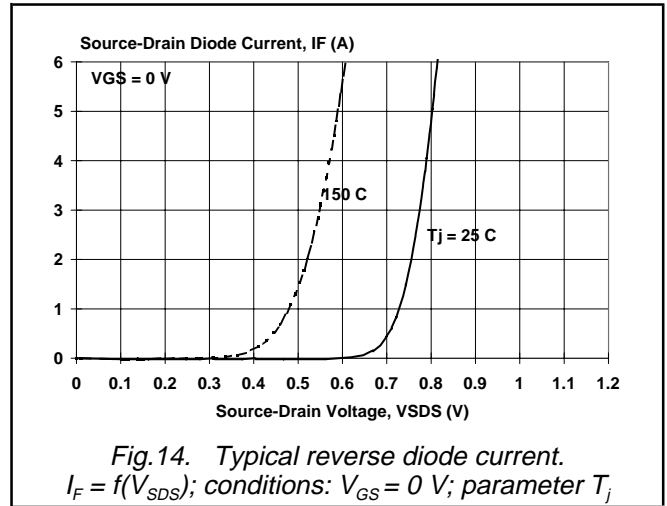
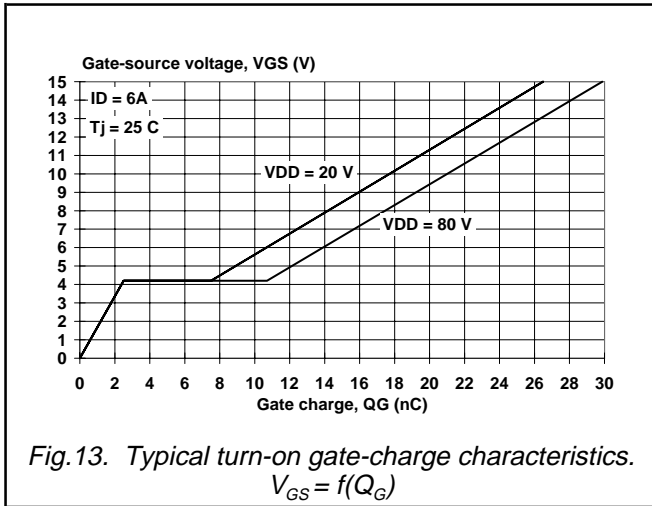
N-channel TrenchMOS™ transistor

PHT6NQ10T



N-channel TrenchMOS™ transistor

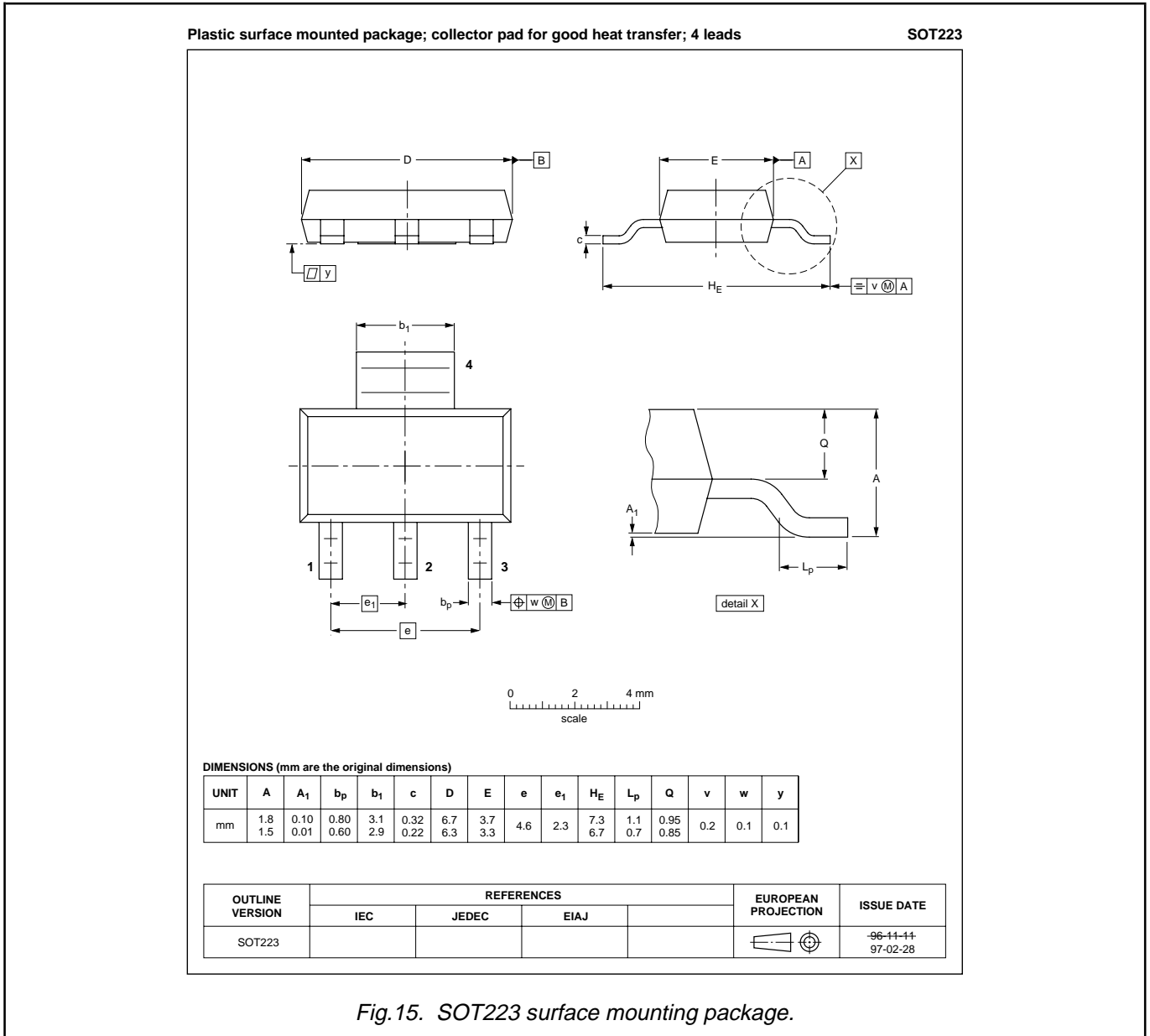
PHT6NQ10T



N-channel TrenchMOS™ transistor

PHT6NQ10T

MECHANICAL DATA



Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to Discrete Semiconductor Packages, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

## N-channel TrenchMOS™ transistor

PHT6NQ10T

**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
<b>© Philips Electronics N.V. 1999</b>	
All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.	
The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.	

**LIFE SUPPORT APPLICATIONS**

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.